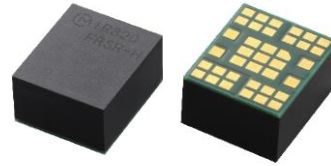


■ MYMGK1R820



■ MYMGK1R820-H Series



Typical unit

FEATURES

- Settable output voltage from 0.7 to 1.8V
- Up to 20A of output current
- Quick response to load change
- Ultra small surface mount package 10.5 x 9.0 x 5.6mm
- High efficiency of 93.2% max.
- Outstanding thermal derating performance
- Over current protection
- On/Off control (Positive logic)
- Power Good signal
- High Reliability
- Meets CISPR 32 class B conducted emission

PRODUCT OVERVIEW

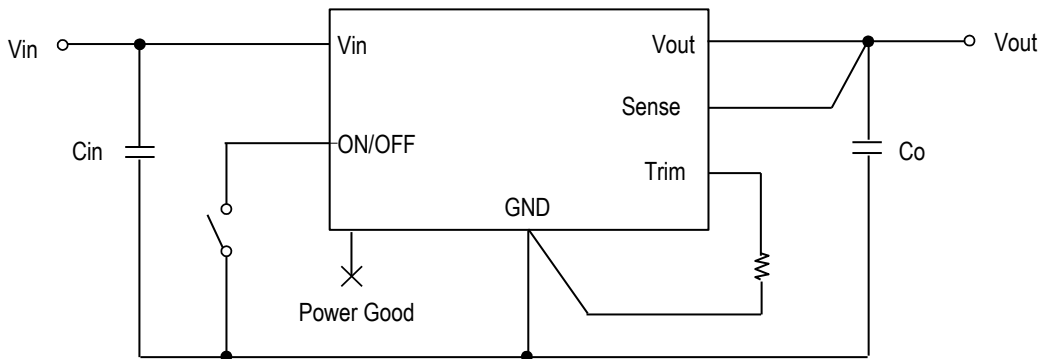
The **MYMGK1R820 series** are miniature MonoBK™, called “MonoBlock”, non-isolated Point-of-Load (PoL) DC-DC power converter for embedded applications. The small form factor measures only 10.5 x 9.0 x 5.6mm. Applications include powering FPGA/CPU’s, datacom/telecom systems, Distributed Bus Architectures (DBA), programmable logic and mixed voltage systems.

The converters have input voltage ranges of 4.5 to 8.0V or 8.0 to 15.0V and a maximum output current of 20A. Based on a fixed frequency synchronous buck converter switching topology, this high power conversion efficient PoL module features settable output voltage 0.7 to 1.8V, On/Off control and Power Good signal output.

These converters also include under voltage lock out (UVLO), output short circuit protection and over-current protection.

SIMPLIFIED APPLICATION

MYMGK1R820 series / MYMGK1R820-H Series



MYMGK1R820FRSR/MYMGK1R820FRSR-H
Cin : 47uF/10V x 2pcs (4.5≤Vin≤5.5V)
or 22uF/25V x 2pcs (5.5<Vin≤8.0V)
Cout : 220uF/4V x 3pcs

MYMGK1R820ERSR/MYMGK1R820ERSR-H
Cin : 22uF/25V x 2pcs
Cout : 220uF/4V x 3pcs

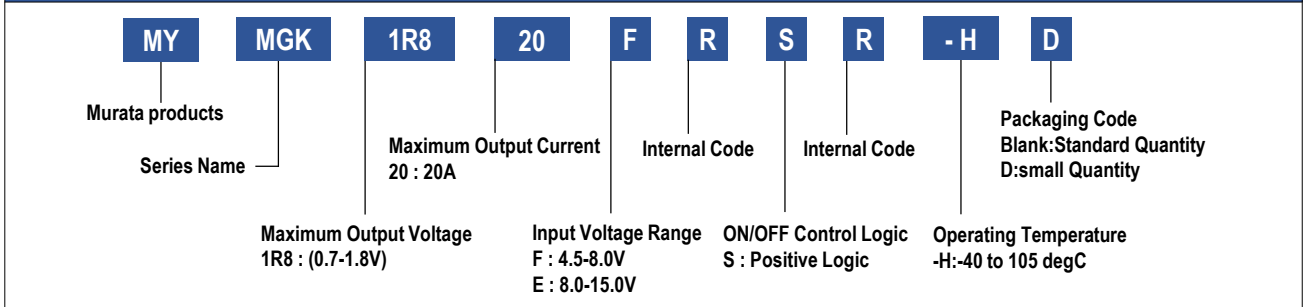
(Typical topology is shown. Murata recommends an external input fuse.)

PERFORMANCE SPECIFICATIONS SUMMARY AND ORDERING GUIDE (Including series products)

PART NUMBER	OUTPUT						INPUT				Efficiency (%)	ON/OFF	Package (mm)
	Vout (V)	Iout (A,max.)	Power (W)	R/N typ. (% of Vout)	Regulation(max.)		Vin typ. (V)	Range (V)	Iin no load (mA)	Iin full load (A)			
					Line(%)	Load(%)							
MYMGK1R820FRSR	0.7-1.8 (typ.:1.8V)	20	36	0.8	±3.0	±1.0	5	4.5 - 8	100	8.1	89.2	Yes (Positive)	10.5 x 9.0 x 5.6
MYMGK1R820ERSR	0.7-1.8 (typ.:1.8V)	20	36	0.8	±1.5	±1.0	12	8 - 15	50	3.5	87.8	Yes (Positive)	10.5 x 9.0 x 5.6
MYMGK1R820FRSR-H	0.7-1.8 (typ.:1.8V)	20	36	0.8	±3.0	±1.0	5	4.5 - 8	100	8.1	89.2	Yes (Positive)	10.5 x 9.0 x 5.6
MYMGK1R820ERSR-H	0.7-1.8 (typ.:1.8V)	20	36	0.8	±1.5	±1.0	12	8 - 15	50	3.5	87.8	Yes (Positive)	10.5 x 9.0 x 5.6
MYMGK1R820FRSRD	0.7-1.8 (typ.:1.8V)	20	36	0.8	±3.0	±1.0	5	4.5 - 8	100	8.1	89.2	Yes (Positive)	10.5 x 9.0 x 5.6
MYMGK1R820ERSRD	0.7-1.8 (typ.:1.8V)	20	36	0.8	±1.5	±1.0	12	8 - 15	50	3.5	87.8	Yes (Positive)	10.5 x 9.0 x 5.6
MYMGK1R820FRSR-HD	0.7-1.8 (typ.:1.8V)	20	36	0.8	±3.0	±1.0	5	4.5 - 8	100	8.1	89.2	Yes (Positive)	10.5 x 9.0 x 5.6
MYMGK1R820ERSR-HD	0.7-1.8 (typ.:1.8V)	20	36	0.8	±1.5	±1.0	12	8 - 15	50	3.5	87.8	Yes (Positive)	10.5 x 9.0 x 5.6

1.All specifications are at typical line voltage, Vout = 1.8V and full load, +25degC unless otherwise noted. Output capacitors are 220uF x 3 ceramic. Input capacitors is 22uF x 2 or 47uF x 2 ceramic and plenty electrolytic capacitors. See detailed specifications. Input and Output capacitors are necessary for our test equipment.
2.Use adequate ground plane and copper thickness adjacent to the converter.

PART NUMBER STRUCTURE



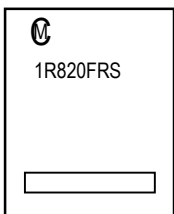
Product Marking

Because of the small size of these products, the product marking contains a character-reduced code to indicate the model number and manufacturing date code. Not all items on the marking are always used. Please note that the marking differs from the product photograph. Here is the layout of the Marking.

Part Number	Product Code
MYMGK1R820FRSR	1R820FRS
MYMGK1R820ERSR	1R820ERS
MYMGK1R820FRSRD	1R820FRS
MYMGK1R820ERSRD	1R820ERS
MYMGK1R820FRSR-H	1R820FRSR-H
MYMGK1R820ERSR-H	1R820ERSR-H
MYMGK1R820FRSR-HD	1R820FRSR-H
MYMGK1R820ERSR-HD	1R820ERSR-H

MYMGK1R820 Series

Layout (reference)

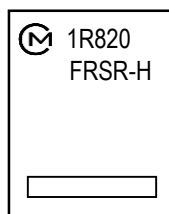


Codes(reference)

- 1Pin Marking
1R820FRS Product code
(Please see product code table beside)
- Internal Manufacturing code

MYMGK1R820-H Series

Layout (reference)



Codes(reference)

- 1Pin Marking
1R820FRSR-H Product code
(Please see product code table beside)
- Internal Manufacturing code

COMMON SPECIFICATION

MECHANICAL(Common)	Conditions	Minimum	Typical	Maximum	Units
Mechanical Dimension	L x W x H	10.5(typ.) x 9.0(typ.) x 5.6(max.)			mm
Weight			1.65		grams
ENVIRONMENTAL(Common)	Conditions	Minimum	Typical	Maximum	Units
Operating Ambient Temperature Range	With Derating (Note 2, 7), MYMGK1R820 series	-40		85	degC
Operating Ambient Temperature Range	With Derating (Note 2, 7), MYMGK1R820-H series	-40		105	degC
Storage Temperature Range	Vin = Zero (no power)	-40		125	degC
Thermal Characterization Parameter(Reference data) Ψ_{j-c}	Vin=12V, Vout=1.8V, Iout=20A (Note 16)		1.5		degC/W
	Vin=12V, Vout=1.8V, Iout=10A (Note 16)		2.0		degC/W
Thermal Protection/Shutdown	Measured in module (Note 9,14)		145		degC
Thermal Protection/Shutdown (Recovery)	Measured in module (Note 9,14)		135		degC
Moisture Sensitivity Level			3		

FUNCTIONAL SPECIFICATIONS OF MYMGK1R820FRSR/MYMGK1R820FRSR-H (Note 1)

ABSOLUTE MAXIMUM RATINGS	Conditions	Minimum	Typical	Maximum	Units
Input Voltage		-0.3		9.6	V
ON/OFF Pin	Power on, referred to -Vin	-0.3		Vin-1.5	V
PGOOD/Trim Pins	Power on, referred to -Vin		Source ONLY		
Vout		0.7		2.0	V
Output Current	Current-limited, no damage, short-circuit protected	0		20	A
Storage Temperature Range	Vin = Zero (no power)	-40		125	degC
Absolute maximums are stress ratings. Exposure of devices to greater than any of these conditions may adversely affect long-term reliability. Proper operation under conditions other than those listed in the Performance/Functional Specifications Table is not implied or recommended.					
INPUT	Conditions	Minimum	Typical	Maximum	Units
Operating Voltage Range		4.5	5	8	V
Start-up Threshold	Rising input voltage		4.3		V
Under Voltage Shutdown	Note 12		4.1		V
Internal Filter Type			Capacitive		
Input Current					
Full Load Conditions	Vin = 5.0V, Vout = 1.8V, Iout = 20A		8.1		A
Low Line	Vin = 4.5V, Vout = 1.8V, Iout = 20A		9		A
No Load Current	Iout=0A, unit = ON		100		mA
Shut-Down Mode Input Current			1		mA
GENERAL and SAFETY	Conditions	Minimum	Typical	Maximum	Units
Efficiency	Vin = 5.0V, Vout = 1.8V, Iout = 20A		89.2		%
	Vin = 5.0V, Vout = 1.0V, Iout = 20A		84.1		
Calculated MTBF (Note 3)	*+40degC, Vin = 5.0V, Vout = 1.8V, Iout = 50%		8x10 ⁶		Hours
DYNAMIC CHARACTERISTICS	Conditions	Minimum	Typical	Maximum	Units
Fixed Switching Frequency			500		kHz
Startup Time (Vin ON)	Vout = 1.8V (Vout = 5% to 90% of Vout)		1.4		ms
Startup Time (Remote ON)	Vout = 1.8V (Vout = 5% to 90% of Vout)		1.4		ms
Dynamic Load Response	(50-100% load step, di/dt)		1.0		A/us
Dynamic Load Peak Deviation	50-100% load step, Note15		±3.0%		% of Vout
FUNCTIONS	Conditions	Minimum	Typical	Maximum	Units
Remote On/Off Control (Note 4)					
Logic					
ON State Range	ON = +1.8Vmin. to +Vin-1.5V max. or left open	1.8		Vin-1.5	V
OFF Stage Range	OFF = -0.3V to +0.6V.max.	-0.3		0.6	V
Control Current	Open collector/drain			-	mA
Power-Good Output (Pulled up to 5.0Vreg(typ.) internally)					
PGood TRUE (HI)		(95% of target Vout) < Vout < (113% of target Vout)			
PGood FALSE (LO)		Out of above range			
PGood FALSE (LO)		Out of above range			

FUNCTIONAL SPECIFICATIONS OF MYMGK1R820FRSR/MYMGK1R820FRSR-H (Note 1)

OUTPUT	Conditions	Minimum	Typical	Maximum	Units
Total Output Power	See Derating	0		36	W
Voltage					
Output Voltage Range	Note 10	0.7		1.8	V
Minimum Loading			None		
Accuracy (50% load, untrimmed)	Vin = 5.0V, Vout = 1.8V, Cout=660uF, Ta = 25degC		± 1		% of Vout
Over Voltage Protection	Note 13		>120%		% of Vout
Under Voltage Protection			<70%		% of Vout
Current					
Output Current Range	Note 2	0		20	A
Current Limit Inception	After warmup		30		A
Short Circuit					
Short Circuit Duration (remove short for recovery)	Output shorted to ground, no damage		Continuous		
Short Circuit Protection Method	Note 5		Hiccup		
Pre-bias Start-up		Converter will start up if the external output voltage is less than set Vout.			
Regulation (Note 8)					
Line Regulation	Vin = min. to max.			± 3	% of Vout
Load Regulation (Note17)	Iout = min. to max.			± 1	% of Vout
Temperature variation	Ta = -40 to 105degC		± 1.5		% of Vout
Total output voltage variation (Note17)	Fixed input voltage			± 3.5	% of Vout
Ripple and Noise (20MHz bandwidth)	Note 6		1		% of Vout
External Output Capacitance Range (Note 11)		660		5000	uF

FUNCTIONAL SPECIFICATIONS OF MYMGK1R820ERSR/MYMGK1R820ERSR-H (Note 1)

ABSOLUTE MAXIMUM RATINGS		Conditions	Minimum	Typical	Maximum	Units
Input Voltage			-0.3		16	V
ON/OFF Pin		Power on, referred to -Vin	-0.3		6.3	V
PGOOD/Trim Pins		Power on, referred to -Vin		Source ONLY		
Vout			0.7		2.0	V
Output Current		Current-limited, no damage, short-circuit protected	0		20	A
Storage Temperature Range		Vin = Zero (no power)	-40		125	degC
Absolute maximums are stress ratings. Exposure of devices to greater than any of these conditions may adversely affect long-term reliability. Proper operation under conditions other than those listed in the Performance/Functional Specifications Table is not implied or recommended.						
INPUT		Conditions	Minimum	Typical	Maximum	Units
Operating Voltage Range			8	12	15	V
Start-up Threshold		Rising input voltage		4.3		V
Under Voltage Shutdown		Note 12		4.1		V
Internal Filter Type				Capacitive		
Input Current						
Full Load Conditions		Vin = 12.0V, Vout = 1.8V, Iout = 20A		3.5		A
Low Line		Vin = 8.0V, Vout = 1.8V, Iout = 20A		5.2		A
No Load Current		Iout=0A, unit = ON		50		mA
Shut-Down Mode Input Current				1		mA
GENERAL and SAFETY		Conditions	Minimum	Typical	Maximum	Units
Efficiency		Vin = 12.0V, Vout = 1.8V, Iout = 20A		87.8		%
		Vin = 12.0V, Vout = 1.0V, Iout = 20A		81.5		
Calculated MTBF (Note 3)		*+40degC, Vin = 12.0V, Vout = 1.8V, Iout = 50%		8x10 ⁶		hours
DYNAMIC CHARACTERISTICS		Conditions	Minimum	Typical	Maximum	Units
Fixed Switching Frequency				500		kHz
Startup Time (Vin ON)		Vout = 1.8V (Vout = 5% to 90% of Vout)		1.4		ms
Startup Time (Remote ON)		Vout = 1.8V (Vout = 5% to 90% of Vout)		1.4		ms
Dynamic Load Response		(50-100% load step, di/dt)		1.0		A/us
Dynamic Load Peak Deviation		50-100% load step, Note15		±3.0%		% of Vout
FUNCTIONS		Conditions	Minimum	Typical	Maximum	Units
Remote On/Off Control (Note 4)						
Logic						
ON State Range		ON = +1.8Vmin. to +6.3V max. or left open	1.8		6.3	V
OFF Stage Range		OFF = -0.1V to +0.5V.max.	-0.3		0.6	V
Control Current		Open collector/drain			-	mA
Power-Good Output (Pulled up to 5.0Vreg(typ.) internally)						
PGood TRUE (HI)			(95% of target Vout) < Vout < (113% of target Vout)			
PGood FALSE (LO)			Out of above range			
OUTPUT		Conditions	Minimum	Typical	Maximum	Units
Total Output Power		See Derating	0		36	W
Voltage						
Output Voltage Range		Note 10	0.7		1.8	V
Minimum Loading				None		
Accuracy (50% load, untrimmed)		Vin = 5.0V, Vout = 1.8V, Cout=660uF, Ta = 25degC		±1		% of Vout
Over Voltage Protection		Note 13		>120%		% of Vout
Under Voltage Protection				<70%		% of Vout
Current						
Output Current Range		Note 2	0		20	A
Current Limit Inception		After warmup		30		A
Short Circuit						
Short Circuit Duration (remove short for recovery)		Output shorted to ground, no damage		Continuous		
Short Circuit Protection Method		Note 5		Hiccup		
Pre-bias Start-up		Converter will start up if the external output voltage is less than set Vout.				
Regulation (Note 8)						
Line Regulation		Vin = min. to max.			±1.5	% of Vout
Load Regulation (Note17)		Iout = min. to max.			±1	% of Vout
Temperature variation		Ta = -40 to 105degC		±1.5		% of Vout
Total output voltage variation (Note17)		Fixed input voltage			±3.5	% of Vout
Ripple and Noise (20MHz bandwidth)		Note 6		1		% of Vout
External Output Capacitance Range (Note 11)			660		5000	uF

Specification Notes

(1) Specifications are typical at +25degC, V_{in} =typical +5.0V(MYMGK1R820FRSR(-H)) or +12.0V.(MYMGK1R820ERSR(-H)), V_{out} =typical (+1.8V), full load, external caps and natural convection unless otherwise indicated. All models are tested and specified with external 220uF x 3 ceramic output capacitors, 22uF x 2 (for MYMGK1R820ERSR(-H) or FRSR(-H)) or 47uF x 2 (for MYMGK1R820FRSR(-H)) ceramic and plenty electrolytic external input capacitors. All capacitors are low ESR types. These capacitors are necessary to accommodate our test equipment and may not be required to achieve specified performance in your applications. However, Murata recommends installation of these capacitors.

(2) Note that Maximum Power Derating curves indicate an average current at typical input voltage. At higher temperatures and/or no airflow, the converter will tolerate brief full current outputs if the total RMS current over time does not exceed the Derating curve.

(3) Mean Time Between Failure is calculated using the Telecordia SR-332 method, +40degC, half output load, natural air convection.

(4) The On/Off Control input should use either a switch or an open collector/open drain transistor referenced to GND. A logic gate may also be used by applying appropriate external voltages which do not exceed $+V_{in}$

(5) "Hiccup" overcurrent operation repeatedly attempts to restart the converter with a brief, full-current output. If the overcurrent condition still exists, the restart current will be removed and then tried again. This short current pulse prevents overheating and damaging the converter. Once the fault is removed, the converter immediately recovers normal operation.

(6) Output noise may be further reduced by adding an external filter. At zero output current, the output may contain low frequency components which exceed the ripple specification. The output may be operated indefinitely with no load.

(7) All models are fully operational and meet published specifications, including "cold start" at -40degC.

(8) Regulation specifications describe the deviation as the line input voltage or output load current is varied from a midpoint value to either extreme.

(9) Thermal Protection/Shutdown temperature is measured with the sensor in the converter.

(10) Do not exceed maximum power specifications when adjusting the output trim.

(11) The maximum output capacitive loads depend on the Equivalent Series Resistance (ESR) of the external output capacitor and, to a lesser extent, the distance and series impedance to the load. Larger caps will reduce output noise but may change the transient response. Newer ceramic caps with very low ESR may require lower capacitor values to avoid instability. Thoroughly test your capacitors in the application.

(12) Do not allow the input voltage to degrade lower than the input under voltage shutdown voltage at all times. Otherwise, you risk having the converter turn off. The under voltage shutdown is not latching and will attempt to recover when the input is brought back into normal operating range.

(13) The outputs are intended to sink appreciable reverse current.

(14) When the temperature decreases below the turn-on threshold, the converter will automatically restart.

(15) About di/dt condition, please refer to the table described later.

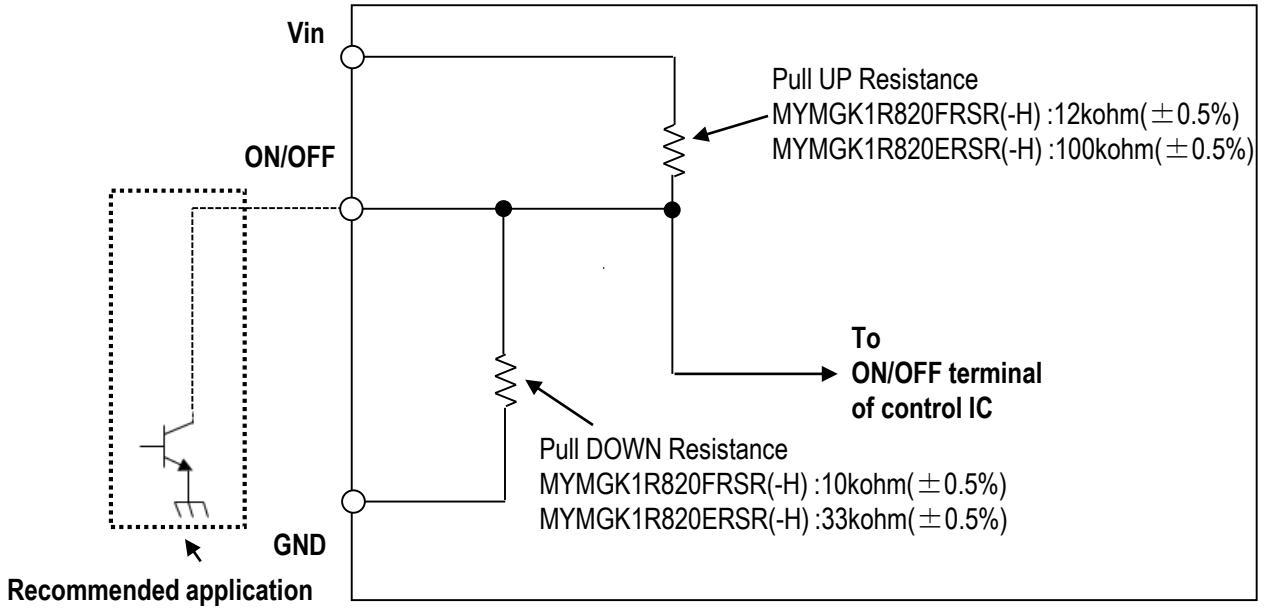
(16) The thermal resistance is reference data, and they are measured with our evaluation board as below.

50.8mm x 60.0mm x 1.6mm (8 Layer, 2oz copper each) FR-4

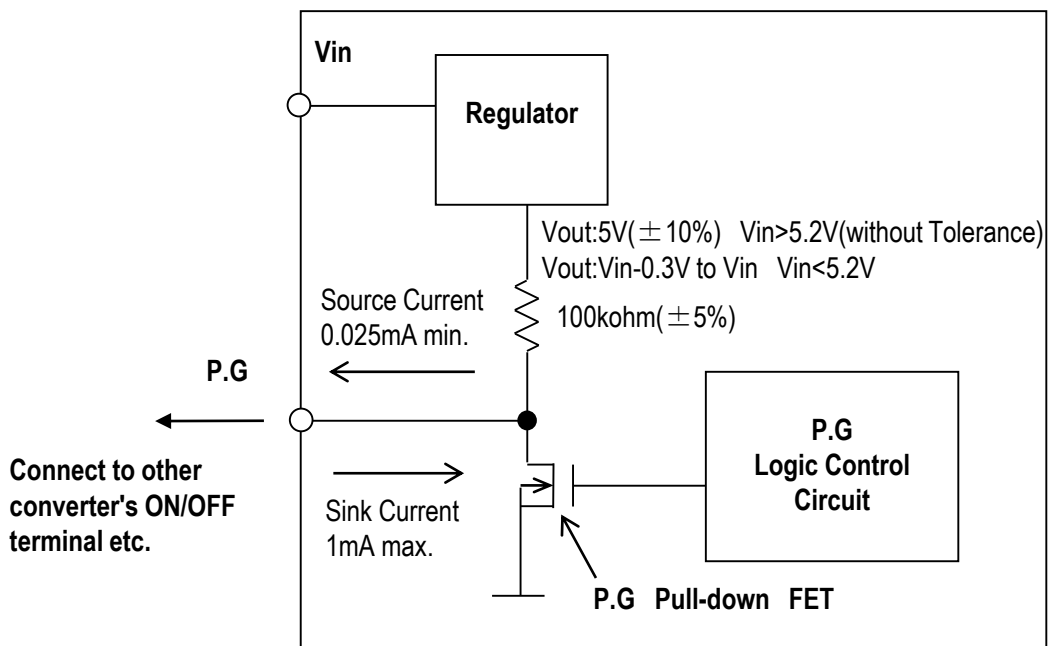
(17) Ensured by design. Not production tested.

Internal Circuit Diagrams

ON/OFF internal circuit diagram and using guide

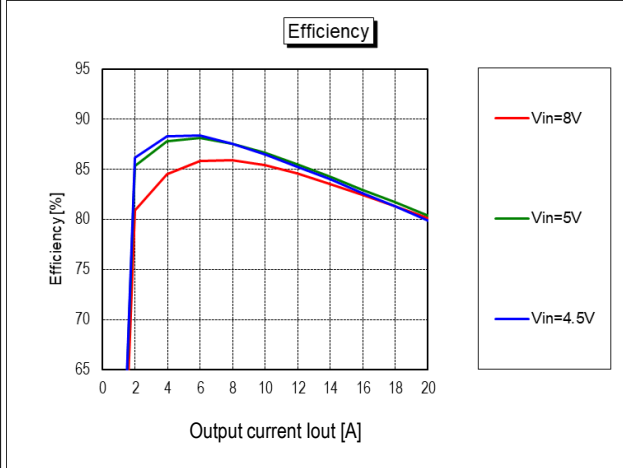


Power Good(P.G) internal circuit diagram and using guide

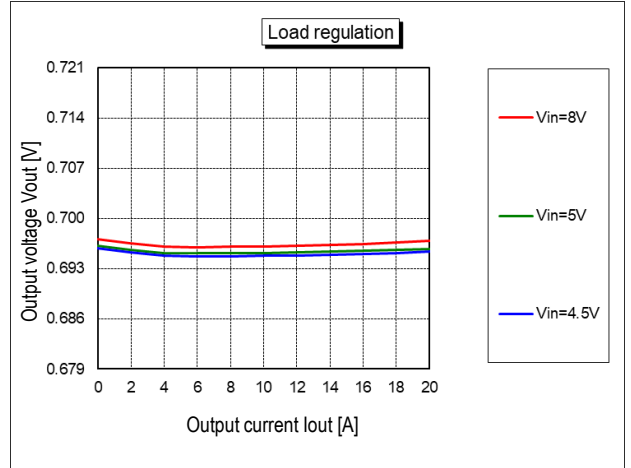


PERFORMANCE DATA AND OSCILLOGRAMS OF MYMGK1R820FRSR/MYMGK1R820FRSR-H

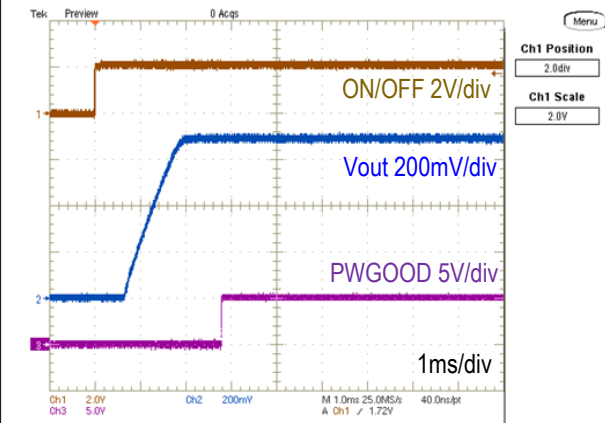
Efficiency vs. Line Voltage and Load Current @ +25degC. (Vout = 0.7V)



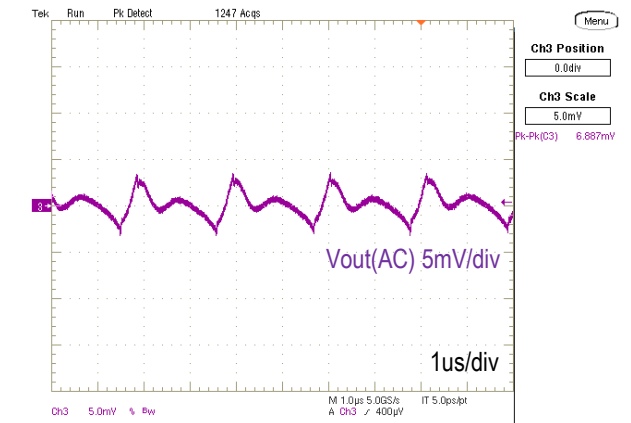
Vout vs. Line Voltage and Load Current @ +25degC. (Vout = 0.7V)



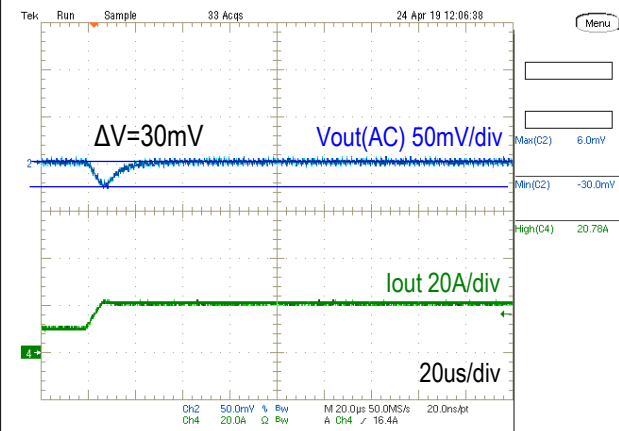
On/Off Enable Delay (Vin=5.0V, Vout=0.7V, Iout=20A, Cload=660uF)
Trace1=ON/OFF 2V/div, Trace2=Vout 200mV/div, Trace3=PWGOOD 5V/div, 1ms/div



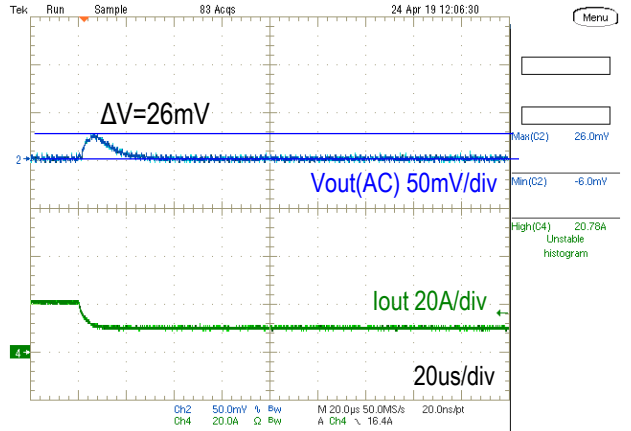
Output Ripple and Noise (Vin=5.0V, Vout=0.7V, Iout=20A, Cload=660uF, Scope BW=20MHz, 5mV/div, 1us/div)



Step Load Transient Response (Vin=5.0V, Vout=0.7V, Cload=660uF, Iout=10A to 20A 1.0A/us) Trace 2=Vout(AC) 50mV/div, Trace 4=Iout 20A/div, 20us/div

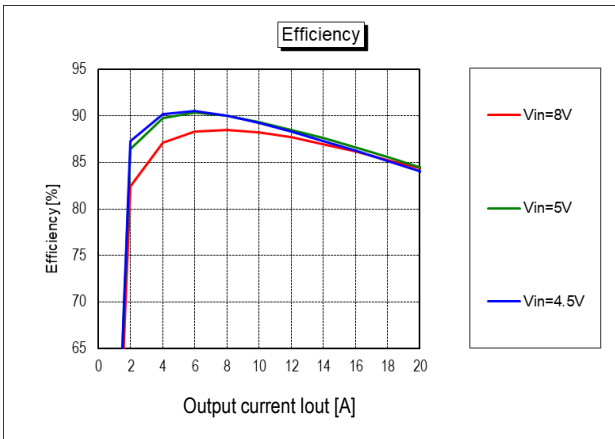


Step Load Transient Response (Vin=5.0V, Vout=0.7V, Cload=660uF, Iout=20 to 10A 1.0A/us) Trace 2=Vout(AC) 50mV/div, Trace 4=Iout 20A/div, 20us/div

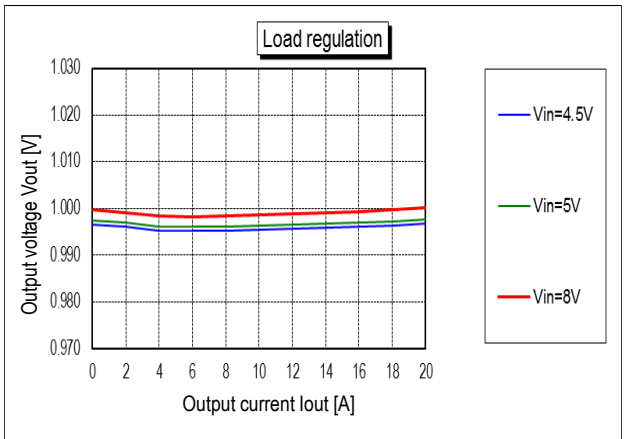


PERFORMANCE DATA AND OSCILLOGRAMS OF MYMGK1R820FRSR/MYMGK1R820FRSR-H

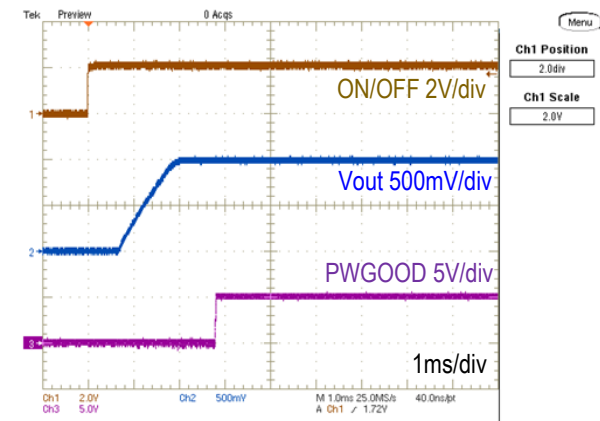
Efficiency vs. Line Voltage and Load Current @ +25degC. (Vout = 1.0V)



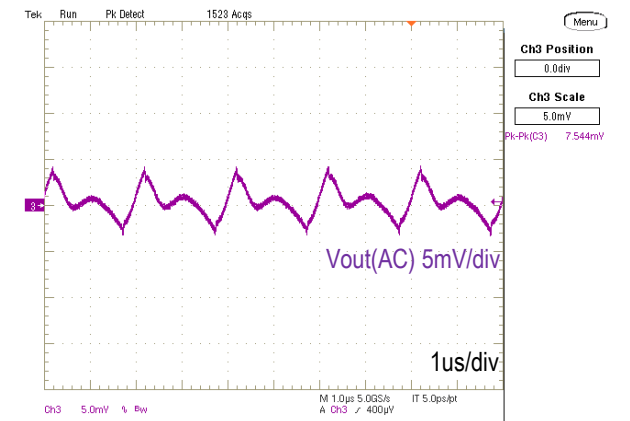
Vout vs. Line Voltage and Load Current @ +25degC. (Vout = 1.0V)



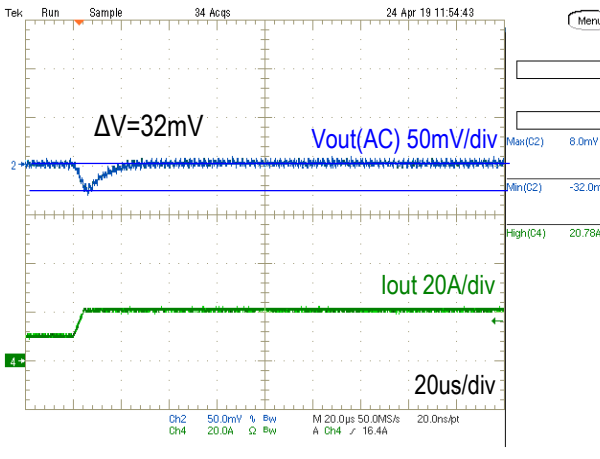
On/Off Enable Delay (Vin=5.0V, Vout=1.0V, Iout=20A, Cload=660uF)
Trace1=ON/OFF 2V/div, Trace2=Vout 500mV/div, Trace3=PWGOOD 5V/div, 1ms/div



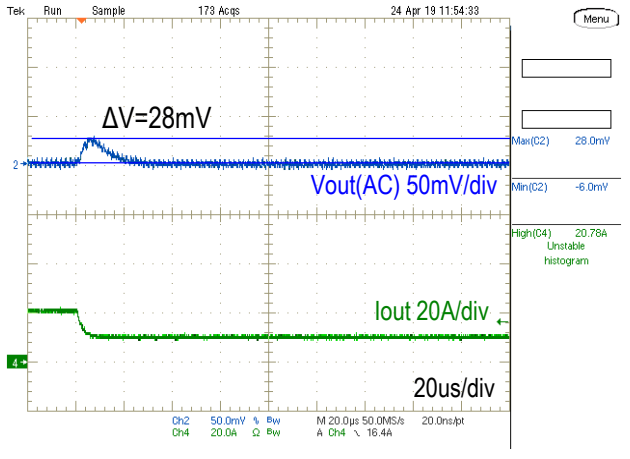
Output Ripple and Noise (Vin=5.0V, Vout=1.0V, Iout=20A, Cload=660uF, Scope BW=20MHz, 5mV/div, 1us/div)



Step Load Transient Response (Vin=5.0V, Vout=1.0V, Cload=660uF, Iout=10A to 20A, 1.0A/us) Trace 2=Vout(AC), 50mV/div, Trace 4=Iout, 20A/div, 20us/div

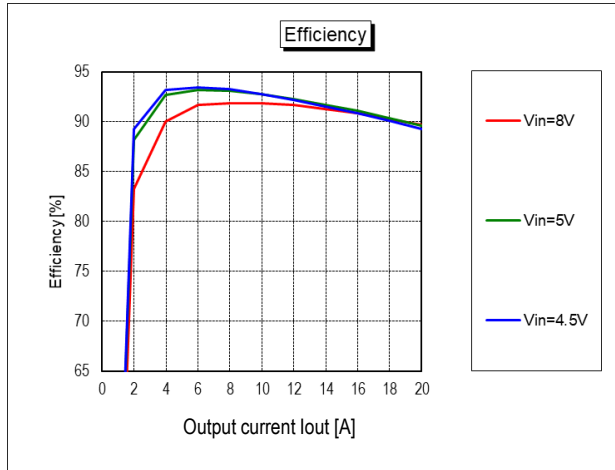


Step Load Transient Response (Vin=5.0V, Vout=1.0V, Cload=660uF, Iout=20 to 10A, 1.0A/us) Trace 2=Vout(AC), 50mV/div, Trace 4=Iout, 20A/div, 20us/div

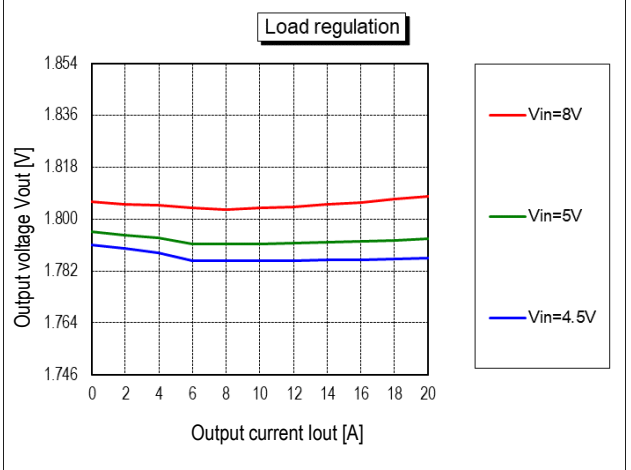


PERFORMANCE DATA AND OSCILLOGRAMS OF MYMGK1R820FRSR/MYMGK1R820FRSR-H

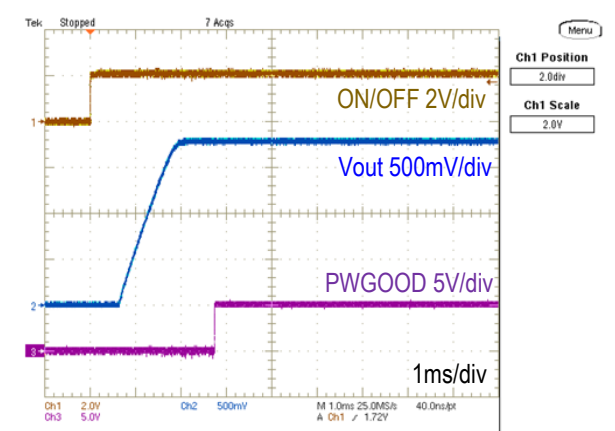
Efficiency vs. Line Voltage and Load Current @ +25degC. (Vout = 1.8V)



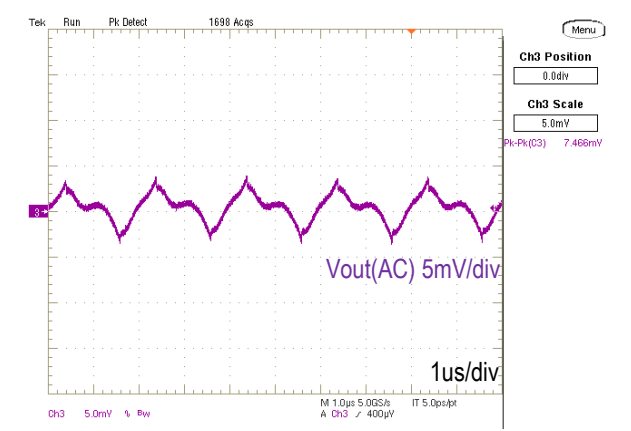
Vout vs. Line Voltage and Load Current @ +25degC. (Vout = 1.8V)



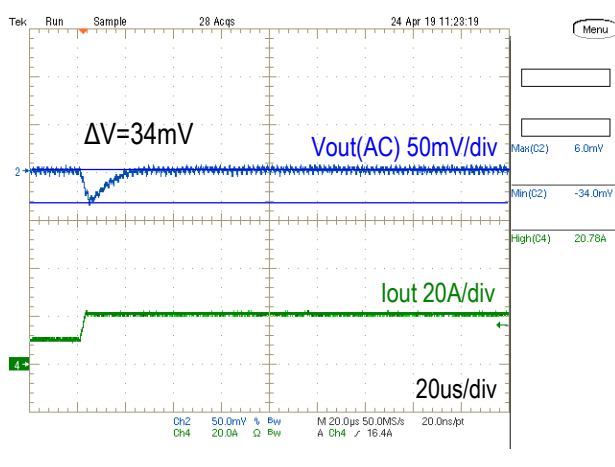
On/Off Enable Delay (Vin=5.0V, Vout=1.8V, Iout=20A, Cload=660uF)
Trace1=ON/OFF 2V/div, Trace2=Vout 500mV/div, Trace3=PWGOOD 5V/div, 1ms/div



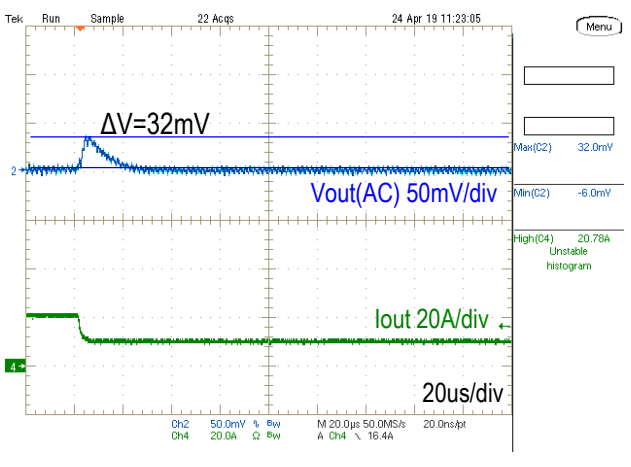
Output Ripple and Noise (Vin=5.0V, Vout=1.8V, Iout=20A, Cload=660uF, Scope BW=20MHz, 5mV/div, 1us/div)



Step Load Transient Response (Vin=5.0V, Vout=1.8V, Cload=660uF, Iout=10A to 20A, 1.0A/us) Trace 2=Vout(AC), 50mV/div, Trace 4=Iout, 20A/div, 20us/div

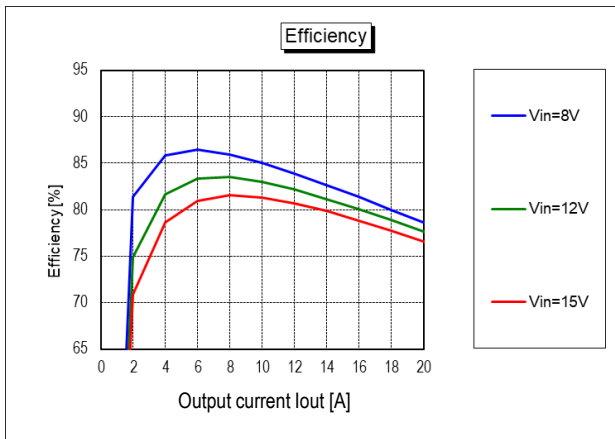


Step Load Transient Response (Vin=5.0V, Vout=1.8V, Cload=660uF, Iout=20 to 10A, 1.0A/us) Trace 2=Vout(AC), 50mV/div, Trace 4=Iout, 20A/div, 20us/div

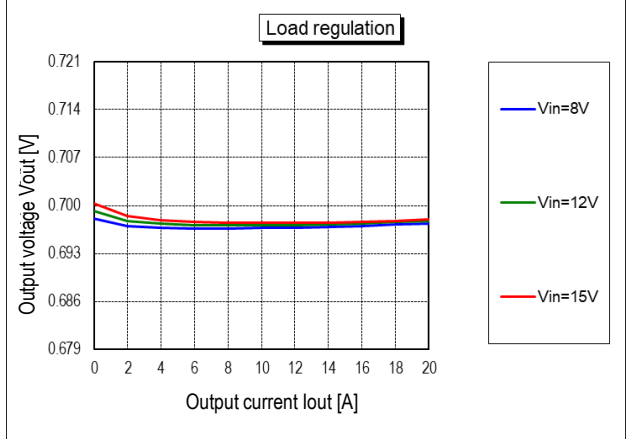


PERFORMANCE DATA AND OSCILLOGRAMS OF MYMGK1R820ERSR/MYMGK1R820ERSR-H

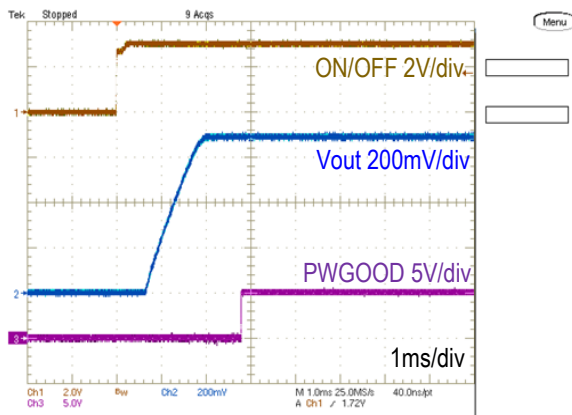
Efficiency vs. Line Voltage and Load Current @ +25degC. (Vout = 0.7V)



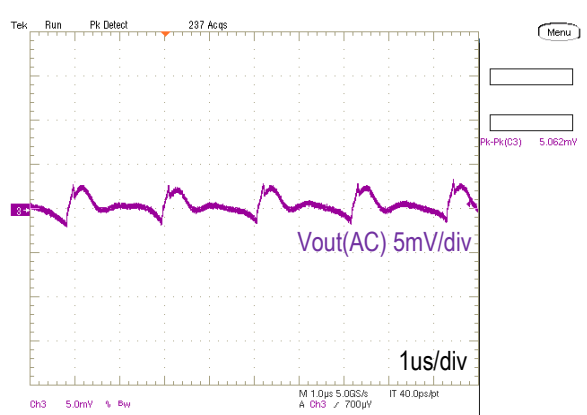
Vout vs. Line Voltage and Load Current @ +25degC. (Vout = 0.7V)



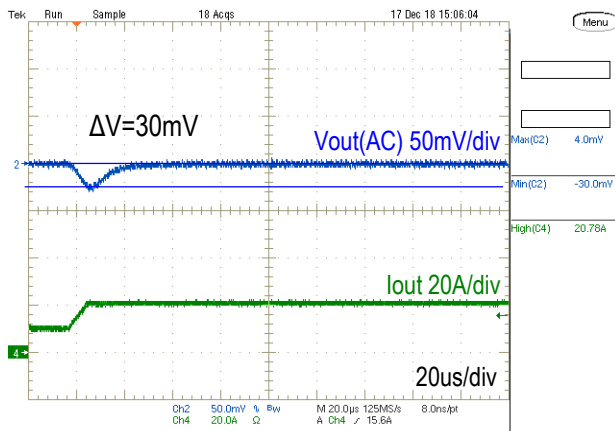
On/Off Enable Delay (Vin=12.0V, Vout=0.7V, Iout=20A, Cload=660uF)
Trace1=ON/OFF 2V/div, Trace2=Vout 200mV/div, Trace3=PWGOOD 5V/div, 1ms/div



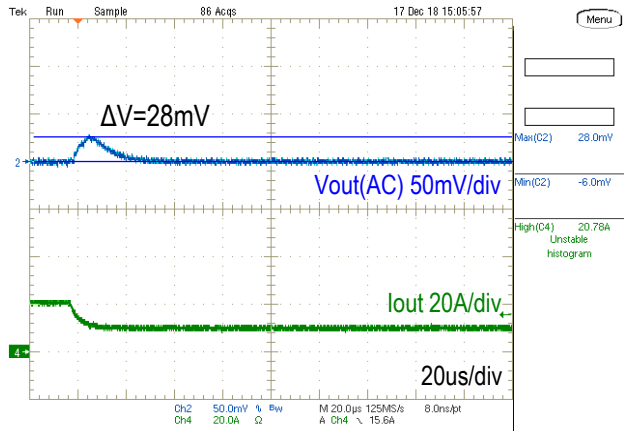
Output Ripple and Noise (Vin=12.0V, Vout=0.7V, Iout=20A, Cload=660uF, Scope BW=20MHz, 5mV/div, 1us/div)



Step Load Transient Response (Vin=12.0V, Vout=0.7V, Cload=660uF, Iout=10A to 20A 1.0A/us) Trace 2=Vout(AC) 50mV/div, Trace 4=Iout 20A/div, 20us/div

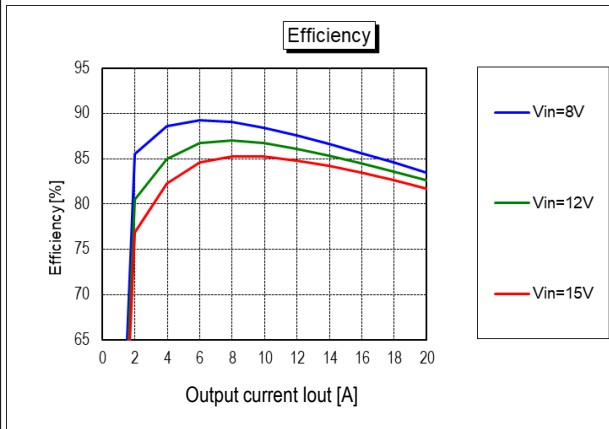


Step Load Transient Response (Vin=12.0V, Vout=0.7V, Cload=660uF, Iout=20 to 10A 1.0A/us) Trace 2=Vout(AC) 50mV/div, Trace 4=Iout 20A/div, 20us/div

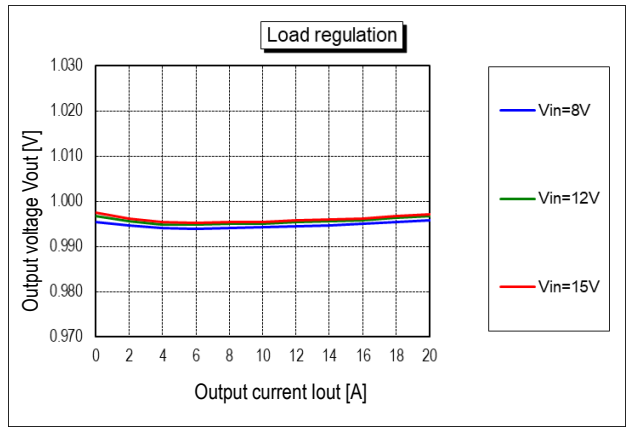


PERFORMANCE DATA AND OSCILLOGRAMS OF MYMGK1R820ERSR/MYMGK1R820ERSR-H

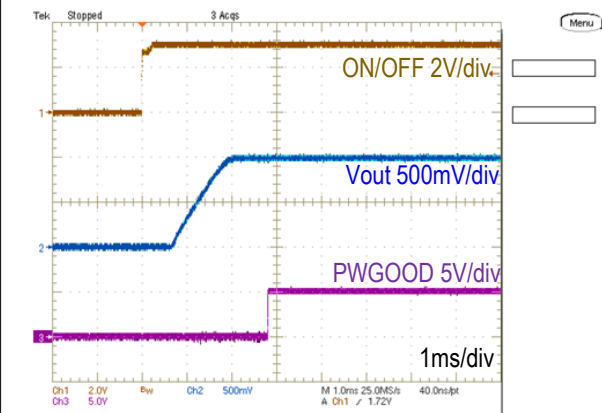
Efficiency vs. Line Voltage and Load Current @ +25degC. (Vout = 1.0V)



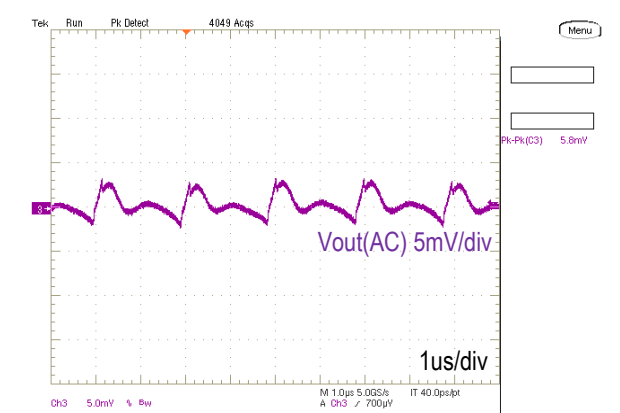
Vout vs. Line Voltage and Load Current @ +25degC. (Vout = 1.0V)



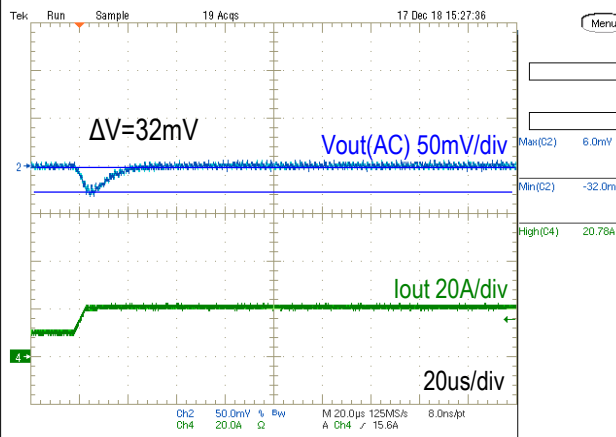
On/Off Enable Delay (Vin=12.0V, Vout=1.0V, Iout=20A, Cload=660uF)
Trace1=ON/OFF 2V/div, Trace2=Vout 500mV/div, Trace3=PWGOOD 5V/div, 1ms/div



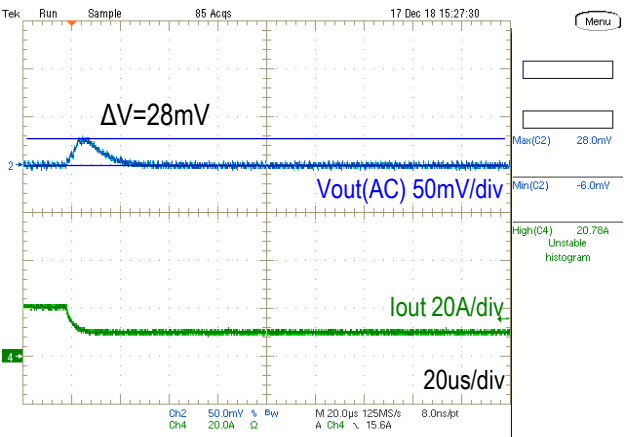
Output Ripple and Noise (Vin=12.0V, Vout=1.0V, Iout=20A, Cload=660uF, Scope BW=20MHz, 5mV/div, 1us/div)



Step Load Transient Response (Vin=12.0V, Vout=1.0V, Cload=660uF, Iout=10A to 20A, 1.0A/us) Trace 2=Vout(AC), 50mV/div, Trace 4=Iout, 20A/div, 20us/div

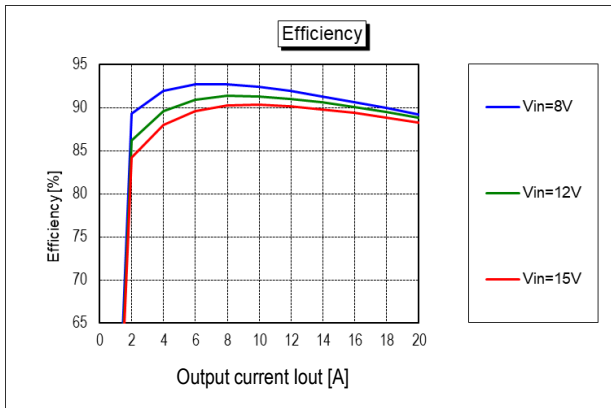


Step Load Transient Response (Vin=12.0V, Vout=1.0V, Cload=660uF, Iout=20 to 10A, 1.0A/us) Trace 2=Vout(AC), 50mV/div, Trace 4=Iout, 20A/div, 20us/div

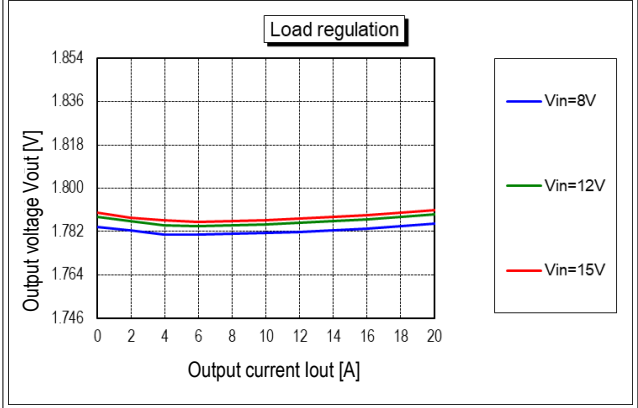


PERFORMANCE DATA AND OSCILLOGRAMS OF MYMGK1R820ERSR/MYMGK1R820ERSR-H

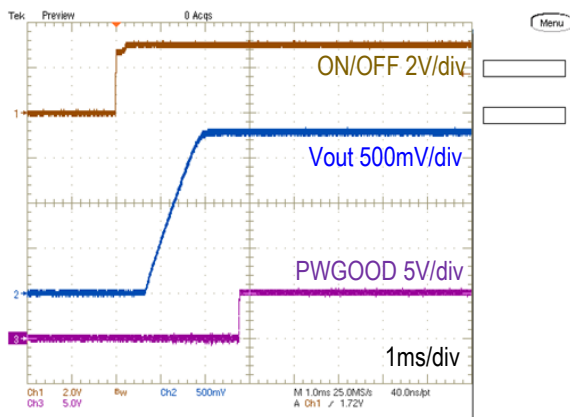
Efficiency vs. Line Voltage and Load Current @ +25degC. (Vout = 1.8V)



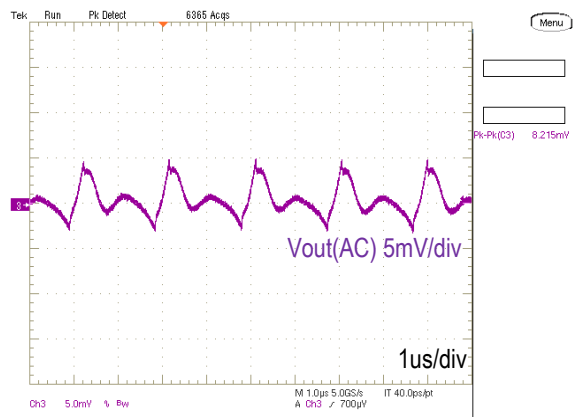
Vout vs. Line Voltage and Load Current @ +25degC. (Vout = 1.8V)



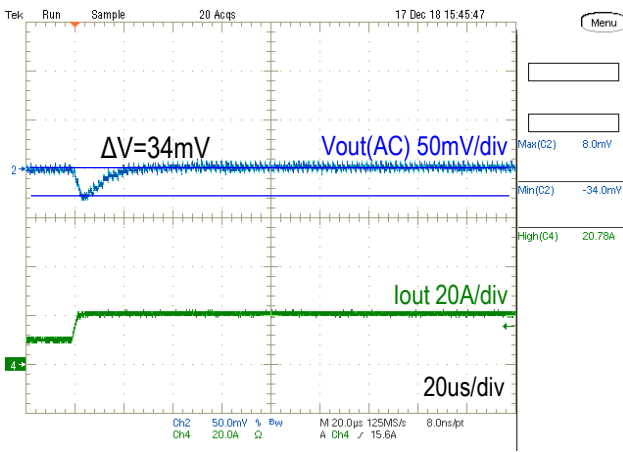
On/Off Enable Delay (Vin=12.0V, Vout=1.8V, Iout=20A, Cload=660uF)
Trace1=ON/OFF 2V/div, Trace2=Vout 500mV/div, Trace3=PWGOOD 5V/div, 1ms/div



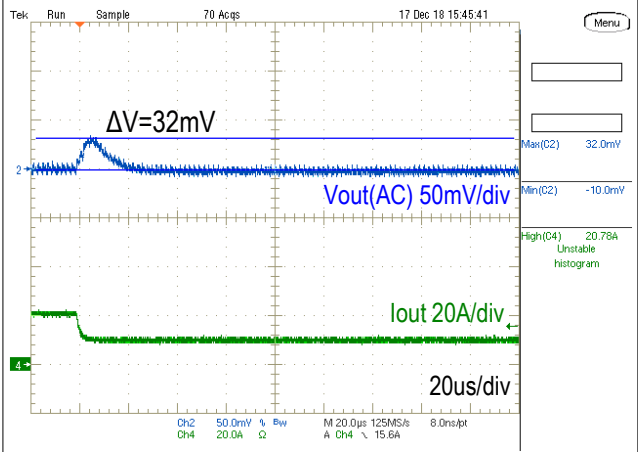
Output Ripple and Noise (Vin=12.0V, Vout=1.8V, Iout=20A, Cload=660uF, Scope BW=20MHz, 5mV/div, 1us/div)



Step Load Transient Response (Vin=12.0V, Vout=1.8V, Cload=660uF, Iout=10A to 20A, 1.0A/us) Trace 2=Vout(AC), 50mV/div, Trace 4=Iout, 20A/div, 20us/div

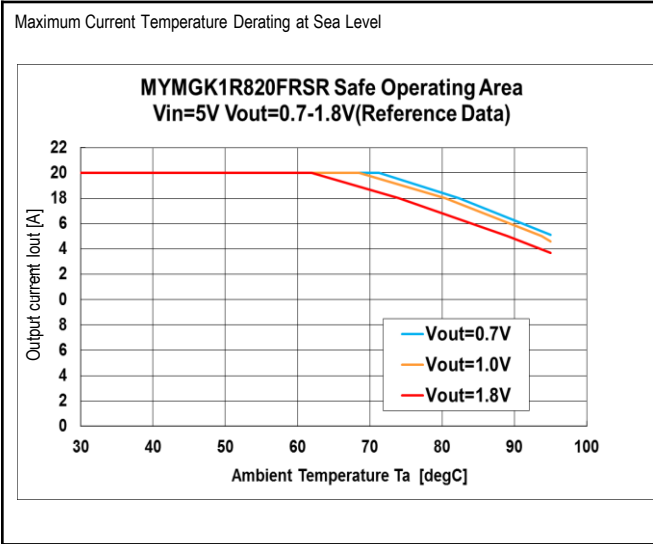


Step Load Transient Response (Vin=12.0V, Vout=1.8V, Cload=660uF, Iout=20 to 10A, 1.0A/us) Trace 2=Vout(AC), 50mV/div, Trace 4=Iout, 20A/div, 20us/div

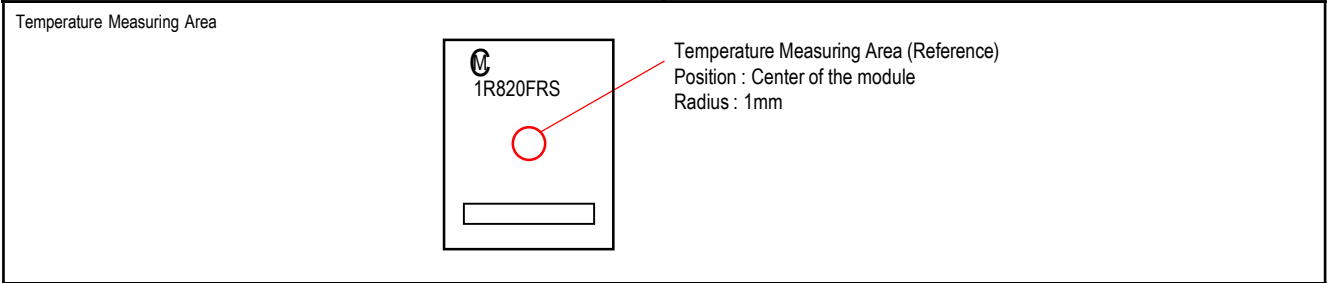
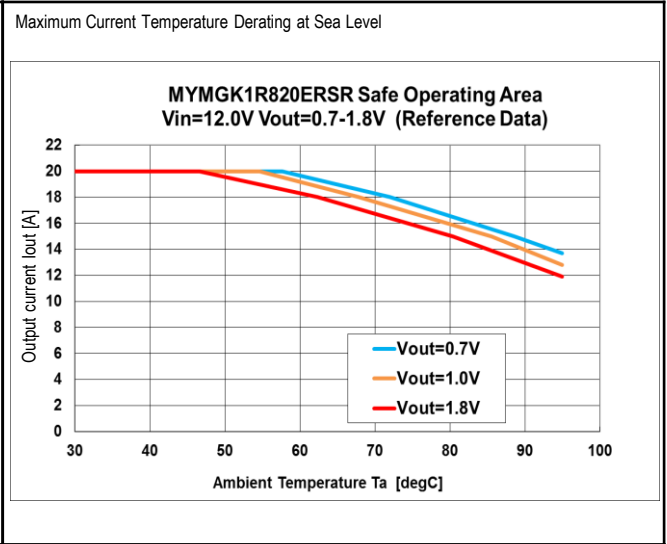


THERMAL DERATINGS OF MYMGK1R820FRSR & MYMGK1R820ERSR

MYMGK1R820FRSR



MYMGK1R820ERSR



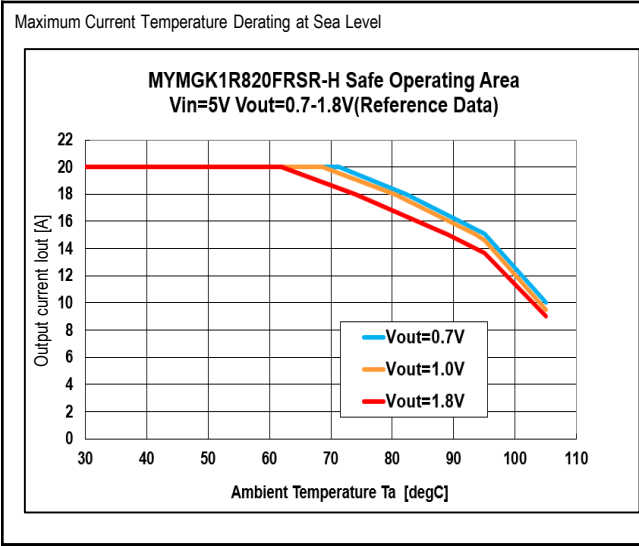
Thermal deratings are evaluated in following condition.

- The product is mounted on 50.8mm x 60.0mm x 1.6mm (8 Layer, 2oz copper each) FR-4 board respectively.
- No forced air flow.

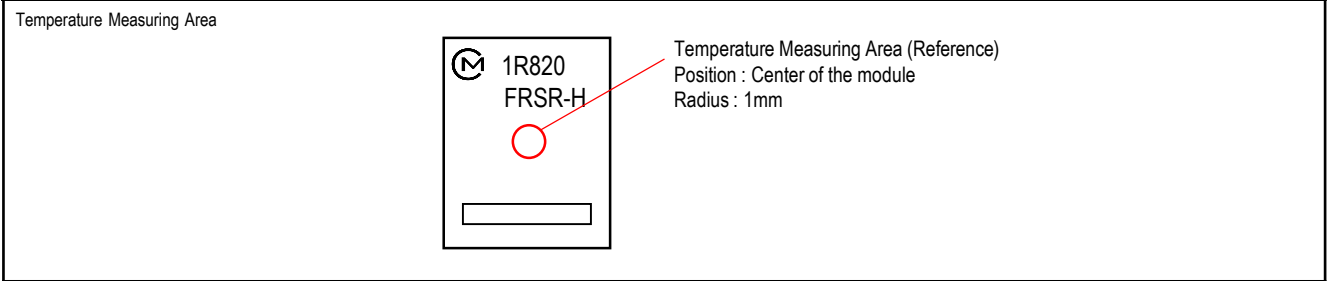
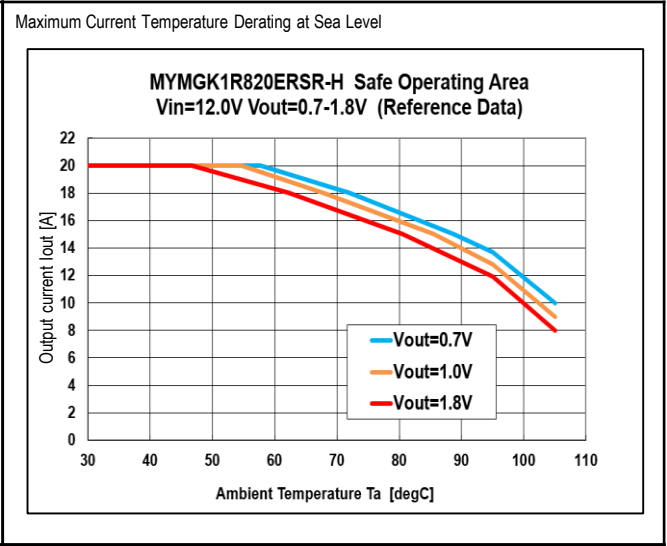
Surface temperature of the product : 110degC max

THERMAL DERATINGS OF MYMGK1R820FRSR-H & MYMGK1R820ERSR-H

MYMGK1R820FRSR-H



MYMGK1R820ERSR-H



Thermal deratings are evaluated in following condition.

- The product is mounted on 50.8mm x 60.0mm x 1.6mm (8 Layer, 2oz copper each) FR-4 board respectively.
- No forced air flow.

Surface temperature of the product : 110degC max

TRANSIENT RESPONSE DATAS OF MYMGK1R820FRSR & MYMGK1R820ERSR & MYMGK1R820FRSR-H & MYMGK1R820ERSR-H

Transient response data at various conditions are showed in following table.

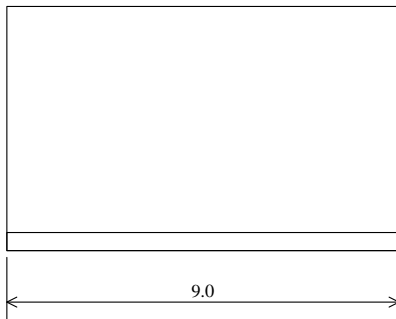
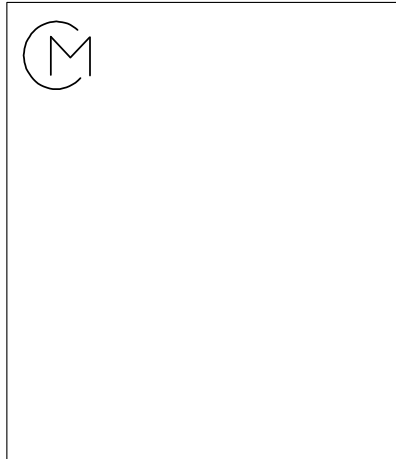
Minimum output capacitance can serve less than 5% x Vout of deviation for 10A load change(1.0A/us).

Vout(V)	Vin(V)	Cout(uF)	Voltage Deviation(mV)
			10-20A Load Step (1.0A/us)
0.7	5	660	30
	12		30
1	5		32
	12		32
1.8	5		34
	12		34

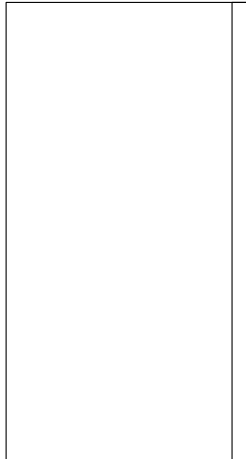
MECHANICAL SPECIFICATIONS

Dimension and Pin Assignment

< Top View >

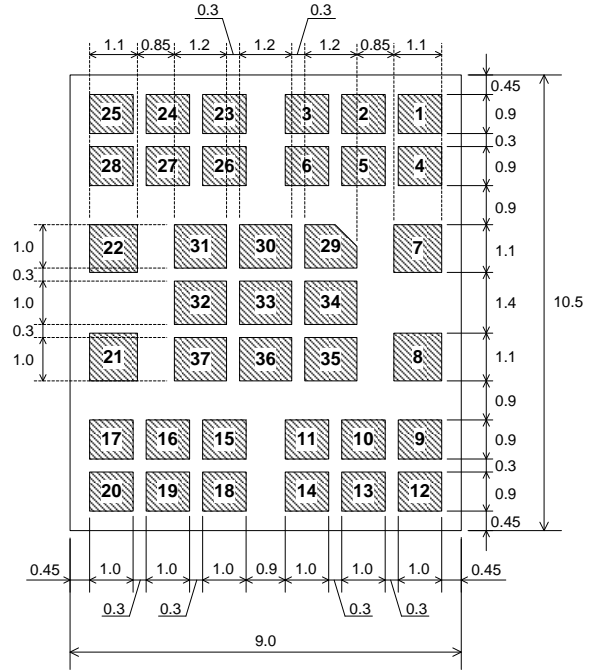


< Side View >



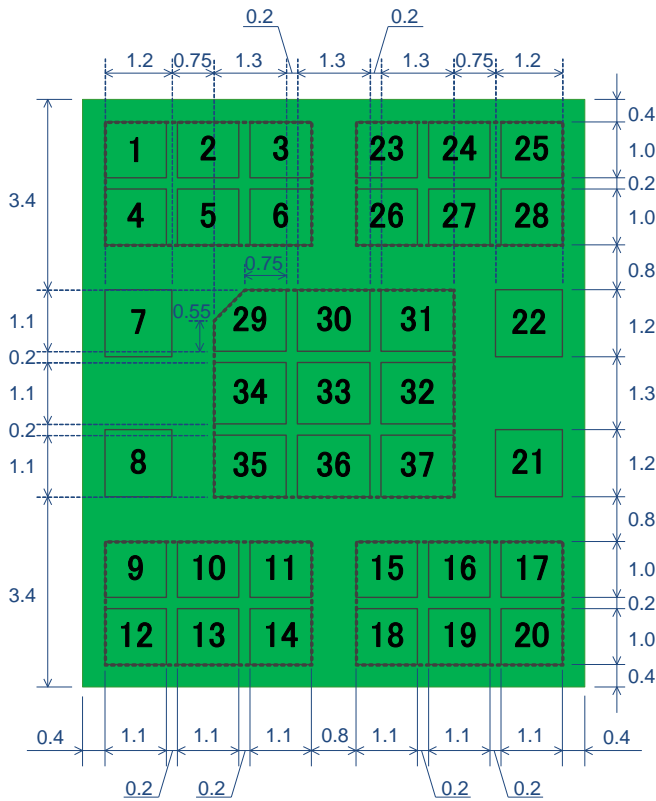
Unit: mm
Tolerances
± 0.15mm

< Bottom View >



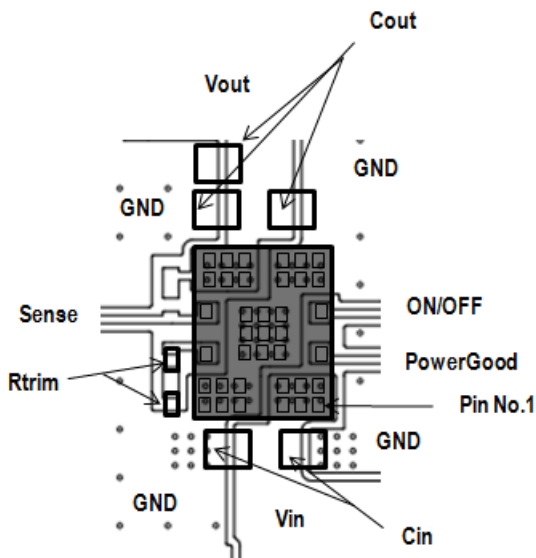
INPUT/OUTPUT CONNECTIONS	
Pin No.	Function
1 - 6	Vin
7	PowerGood
8	ON/OFF
9 - 14	GND
15 - 20	Vout
21	Sense
22	Trim
23 - 28	GND
29 - 37	GND(Thermal Pad)

Recommended Board Land Pattern (Top View)



Unit: mm

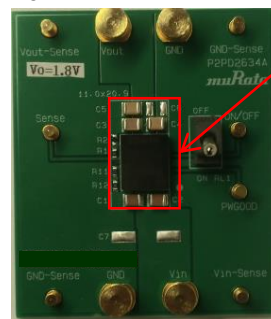
Example of Pattern Layout (Top View)



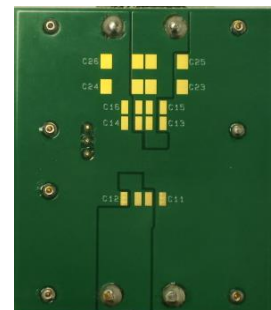
Picture

20.9x11.0(mm)

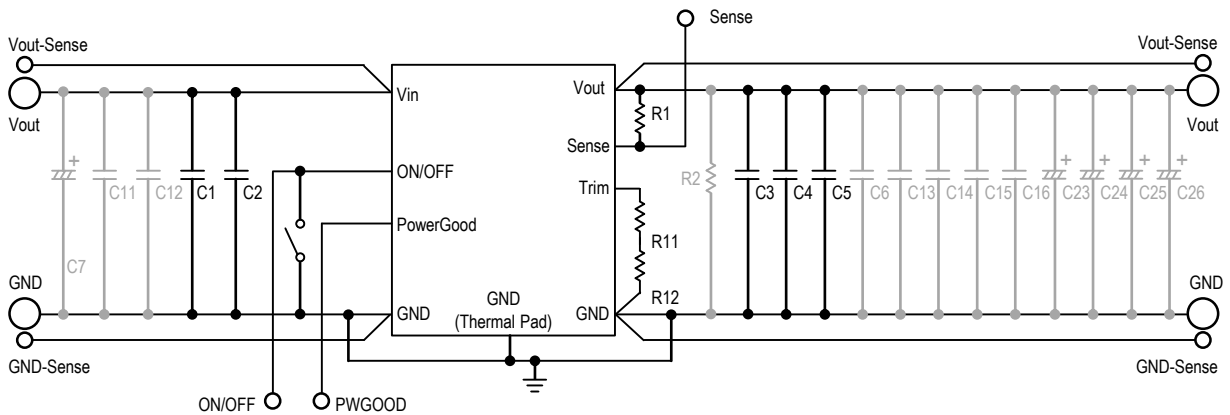
TOP VIEW



BOTTOM VIEW



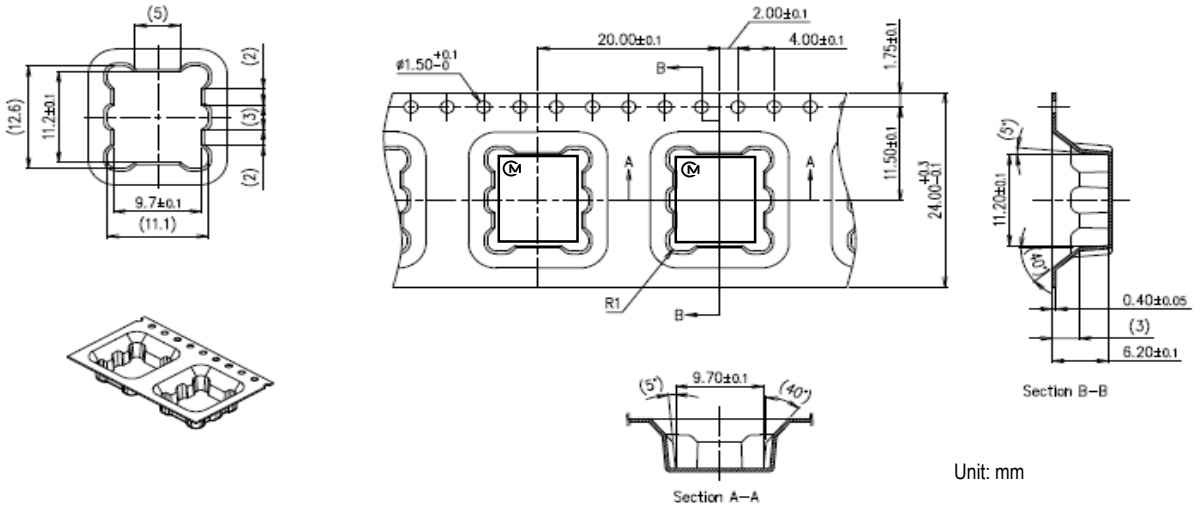
Application Circuit & BOM list (Evaluation Board)



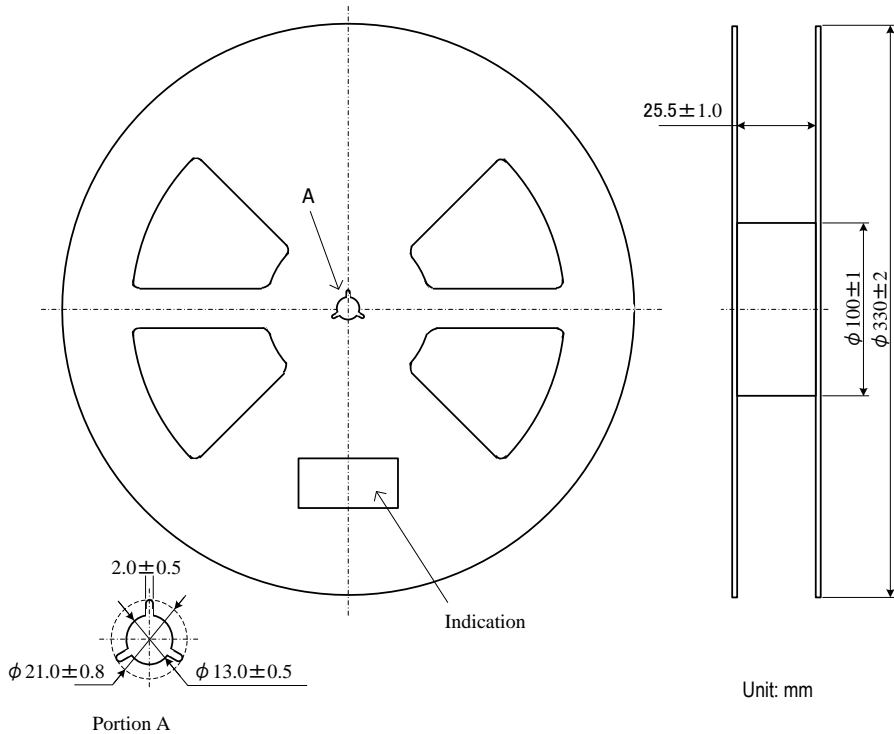
	MYMGK1R820FRSR MYMGK1R820FRSR-H *4.5≤Vin(V)≤5.5	MYMGK1R820FRSR MYMGK1R820FRSR-H *5.5≤Vin(V)≤8.0	MYMGK1R820ERSR MYMGK1R820ERSR-H
C1, C2	47uF/10V GRM32ER71A476KE15 (Murata)	22uF/25V GRM32ER71E226KE15 (Murata)	22uF/25V GRM32ER71E226KE15 (Murata)
C3, C4, C5	220uF/4V GRM32EC80G227ME05 (Murata)	220uF/4V GRM32EC80G227ME05 (Murata)	220uF/4V GRM32EC80G227ME05 (Murata)
R1	1005, Chip resister, 0 ohm	1005, 0 ohm	1005, 0 ohm
R11, R12	1005, Chip resister	1005, Chip resister	1005, Chip resister
C6, C7, C13, C14, C15, C16, C23, C24, C25, C26, R2	No mount	No mount	No mount

TAPE AND REEL INFORMATION

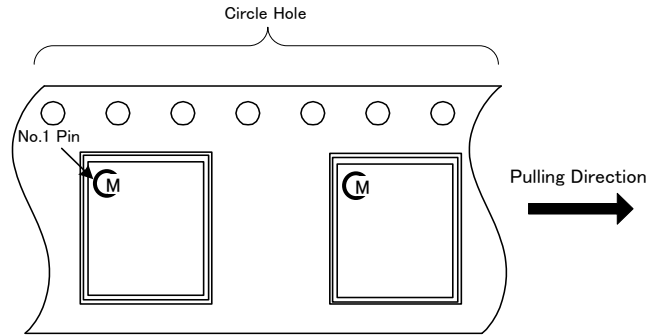
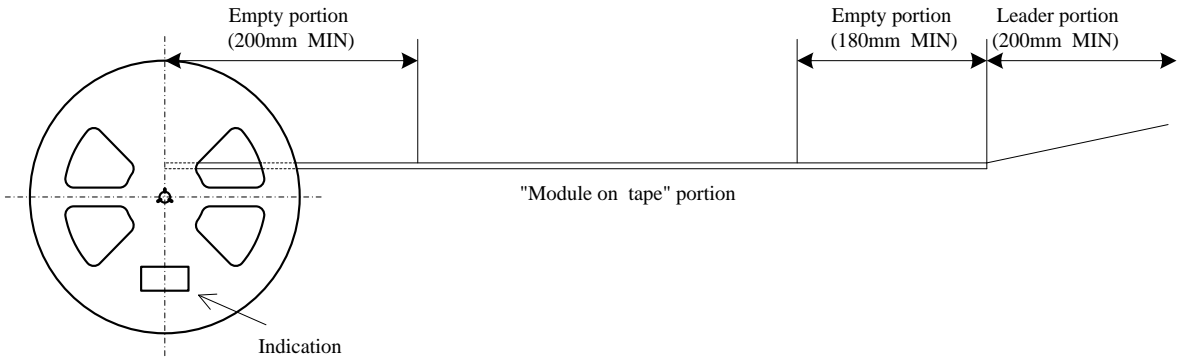
Tape Dimension



Reel Dimension



TAPE SPECIFICATIONS



Note

1. The adhesive strength of the protective tape must be within 0.1-1.3N.
2. Each reel contains the quantities such as the table below.
3. Each reel set in moisture-proof packaging because of MSL 3.
4. No vacant pocket in "Module on tape" section.
5. The reel is labeled with Murata part number and quantity.
6. The color of reel is not specified.

Part Number	Qty(pcs)
MYMGK1R820FRSR	400
MYMGK1R820ERSR	400
MYMGK1R820FRSRD	100
MYMGK1R820ERSRD	100
MYMGK1R820FRSR-H	400
MYMGK1R820ERSR-H	400
MYMGK1R820FRSR-HD	100
MYMGK1R820ERSR-HD	100

TECHNICAL NOTES

Input Fuse

Certain applications and/or safety agencies may require fuses at the inputs of power conversion components. Fuses should also be used when there is the possibility of sustained input voltage reversal which is not current limited. For greatest safety, we recommend a fast blow fuse installed in the ungrounded input supply line. The installer must observe all relevant safety standards and regulations. For safety agency approvals, install the converter in compliance with the end-user safety standard.

Input Under-Voltage Shutdown and Start-Up Threshold

Under normal start-up conditions, converters will not begin to regulate properly until the ramping-up input voltage exceeds and remains at the Start-Up Threshold Voltage (see Specifications). Once operating, converters will not turn off until the input voltage drops below the Under-Voltage Shutdown Limit. Subsequent restart will not occur until the input voltage rises again above the Start-Up Threshold. This built-in hysteresis prevents any unstable on/off operation at a single input voltage.

Users should be aware however of input sources near the Under-Voltage Shutdown whose voltage decays as input current is consumed (such as capacitor inputs), the converter shuts off and then restarts as the external capacitor recharges. Such situations could oscillate. To prevent this, make sure the operating input voltage is well above the UV Shutdown voltage at all times.

Start-Up Time

Assuming that the output current is set at the rated maximum, the Vin to Vout Start-Up Time (see Specifications) is the time interval between the point when the ramping input voltage crosses the Start-Up Threshold and the fully loaded regulated output voltage enters and remains within its specified accuracy band. Actual measured times will vary with input source impedance, external input capacitance, input voltage slew rate and final value of the input voltage as it appears at the converter.

These converters include a soft start circuit to moderate the duty cycle of its PWM controller at power up, thereby limiting the input inrush current. The On/Off Remote Control interval from On command to Vout regulated assumes that the converter already has its input voltage stabilized above the Start-Up Threshold before the On command. The interval is measured from the On command until the output enters and remains within its specified accuracy band. The specification assumes that the output is fully loaded at maximum rated current. Similar conditions apply to the On to Vout regulated specification such as external load capacitance and soft start circuitry.

Recommended Input Filtering

The user must assure that the input source has low AC impedance to provide dynamic stability and that the input supply has little or no inductive content, including long distributed wiring to a remote power supply. For best performance, we recommend installing a low-ESR capacitor immediately adjacent to the converter's input terminals.

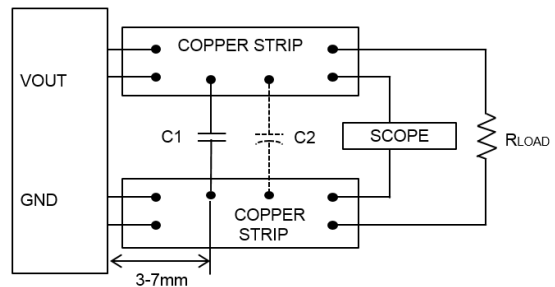
The capacitor should be a ceramic type such as the Murata GRM32 series and a electrolytic type such as Panasonic OS-CON series. Initial suggested capacitor values are 22 uF x 2 or 47uF x 2 ceramic type and 1000uF x 1 electrolytic type, rated at twice the expected maximum input voltage. Make sure that the input terminals do not go below the under voltage shutdown voltage at all times. More input bulk capacitance may be added in parallel (either electrolytic or tantalum) if needed.

Recommended Output Filtering

The converter will achieve its rated output ripple and noise with additional external capacitor. The user may install more external output capacitance reduce the ripple even further or for improved dynamic response. Again, use low-ESR ceramic (Murata GRM32 series). Initial values of 220 uF x 3 ceramic type may be tried, either single or multiple capacitors in parallel. Mount these close to the converter. Measure the output ripple under your load conditions. Use only as much capacitance as required to achieve your ripple and noise objectives. Excessive capacitance can make step load recovery sluggish or possibly introduce instability. Do not exceed the maximum rated output capacitance listed in the specifications.

Output Noise

All models in this converter series are tested and specified for output noise using designated external output components, circuits and layout as shown in the figures below. In the figure below, the two copper strips simulate real-world printed circuit impedances between the power supply and its load. In order to minimize circuit errors and standardize tests between units, scope measurements should be made using BNC connectors or the probe ground should not exceed one half inch and soldered directly to the test circuit.



C1=220uF x 3 CERAMIC
C2=OPEN

Figure : Measuring Output Ripple and Noise

Minimum Output Loading Requirements

All models regulate within specification and are stable under no load to full load conditions. Operation under no load might however slightly increase output ripple and noise.

Thermal Shutdown

To prevent many over temperature problems and damage, these converters include thermal shutdown circuitry. If environmental conditions cause the temperature of the converter's to rise above the Operating Temperature Range up to the shutdown temperature, an on-board electronic temperature sensor will power down the unit. When the temperature decreases below the turn-on threshold, the converter will automatically restart.

CAUTION: If you operate too close to the thermal limits, the converter may shut down suddenly without warning. Check your application to avoid unplanned thermal shutdown.

Temperature Derating Curves

The graphs in this data sheet illustrate typical operation under a variety of conditions. The derating curves show limit of the output current with increasing the continuous ambient temperature. Note that these are AVERAGE measurements.

Note that the temperatures are of the ambient airflow, not the converter itself which is obviously running at higher temperature than the outside air. Also note that very low flow rates (below about 25 LFM) are similar to “natural convection,” that is, not using fan-forced airflow. Murata makes Characterization measurements in a closed cycle wind tunnel with calibrated airflow. We use both thermocouples and an infrared camera system to observe thermal performance.

CAUTION: These graphs are all collected at slightly above Sea Level altitude. Be sure to reduce the derating for lower density atmosphere.

Output Current Limiting

Current limiting inception is defined as the point at which full power falls below the rated tolerance. See the Performance/Functional Specifications. Note particularly that the output current may briefly rise above its rated value in normal operation as long as the average output power is not exceeded. This enhances reliability and continued operation of your application. If the output current is too high, the converter will enter the short circuit condition.

Output Short Circuit Condition

When a converter is in current-limit mode, the output voltage will drop as the output current demand increases. Following a time-out period, the converter will restart, causing the output voltage to begin ramping up to its appropriate value. If the short-circuit condition persists, another shutdown cycle will initiate. This rapid on/off cycling is called “hiccup mode”. The hiccup cycling reduces the average output current, thereby preventing excessive internal temperatures and/or component damage. A short circuit can be tolerated indefinitely.

The “hiccup” system differs from older latching short circuit systems because you do not have to power down the converter to make it restart. The system will automatically restore operation as soon as the short circuit condition is removed.

Output Voltage Remote Sense

This function is capable to compensate up the voltage drop between the output and input of load. The voltage of the Vout pin must NOT be over their allowed maximum voltage if using the remote sense. The sense trace should be connected to Vout line as shortly as possible. The sense trace should be shielded by GND line or something else to reduce noise pick up. The sense line length is recommended within 10cm for output voltage stability.

If the remote sense is not needed, the Sense pin should be connected to the Vout pin directly.

UVP/OVP Function

This product monitors a resistor divided feedback voltage to detect over and under voltage. When the feedback voltage becomes lower than 70% of the target voltage, after 1ms, the product latches OFF. The converter restarts after a hiccup delay (about 16 ms). This function is enabled 1.5ms after the soft-start is completed.

When the feedback voltage becomes higher than 120% of the target voltage, the circuit operates sink-mode to decrease output voltage. If the output voltage reaches UV threshold, the device restarts after a hiccup delay. If the OV condition remains, the converter will not start until the OV condition is removed.

Remote On/Off Control

Please refer to the Connection Diagram on page 1 for On/Off connections.

Positive logic models are enabled when the On/Off pin is left open or is pulled high to Vin with respect to GND. An internal bias current causes the OVP open pin to rise to Vin. Positive-polarity devices are disabled when the On/Off is grounded or brought to within a low voltage (see Specifications) with respect to GND.

Dynamic control of the On/Off function should be able to sink appropriate signal current when brought low and withstand appropriate voltage when brought high. Be aware too that there is a finite time in milliseconds (see Specifications) between the time of On/Off Control activation and stable, regulated output. This time will vary slightly with output load type and current and input conditions.

Output Capacitive Load

Users should only consider adding capacitance to reduce switching noise and/or to handle spike current load steps. Install only enough capacitance to achieve noise objectives. Excess external capacitance may cause regulation problems, degraded transient response and possible oscillation or instability.

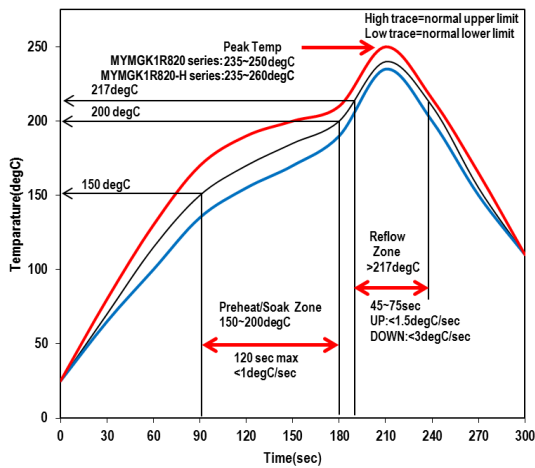
Soldering Guidelines

Murata recommends the specifications below when installing these converters. These specifications vary depending on the solder type. Exceeding these specifications may cause damage to the product. Your production environment may differ therefore please thoroughly review these guidelines with your process engineers.

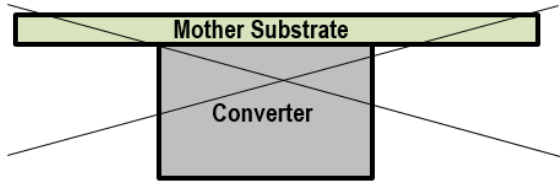
MYMGK1R820 series can be reflowed once. MYMGK1R820-H series can be reflowed twice.

Reflow Solder Operations for Surface-mount products	
For Sn/Ag/Cu based solders:	
Preheat Temperature	Less than 1degC per second
Time over Liquidus	45 to 75 seconds
Maximum Peak Temperature	MYMGK1R820 series:250degC
	MYMGK1R820-H series:260degC
Cooling Rate	Less than 3degC per second
For Sn/Pb based solders:	
Preheat Temperature	Less than 1degC per second
Time over Liquidus	60 to 75 seconds
Maximum Peak Temperature	235degC
Cooling Rate	Less than 3degC per second

Recommended Lead-free Solder Reflow Profile



CAUTION: Do not reflow the converter as follows, because the converter may fall from the substrate during reflowing.



Pb-free solder processes

For Pb-free solder processes, the product is qualified for MSL 3 according to IPC/JEDEC standard J-STD-020D. During reflow PRODUCT must not exceed 260degC at any time.

Dry Pack Information

Products intended for Pb-free reflow soldering processes are delivered in standard moisture barrier bags according to IPC/JEDEC standard J-STD-033. (Handling, packing, shipping and use of moisture/reflow sensitivity surface mount devices.) Using products in high temperature Pb-free soldering processes requires dry pack storage and handling. In case the products have been stored in an uncontrolled environment and no longer can be considered dry, the modules must be baked according to J-STD-033.

Output Voltage Adjustment

The output voltage may be adjusted over a limited range by connecting an external trim resistor (Rtrim) between the Trim pin and GND pin. The Rtrim resistor must be a 1/10W precision metal film type, ±0.5% accuracy or better with low temperature coefficient, ±100 ppm/degC. or better. Mount the resistor close to the converter with very short leads or use a surface mount trim resistor. In the table below, the estimated resistance is given at limited condition ; Vin:typ., Ta:25degC, Iout:max., Cout:660uF. (Please look at Test Circuit which is shown below). Do not exceed the specified limits of the output voltage or the converter's maximum power rating when applying these resistors. Also, avoid high noise at the Trim input. However, to prevent instability, you should never connect any capacitors between Trim pin and GND pin.

Output Voltage	Estimated Rtrim (kohm)	
	MYMGK1R820FRSR MYMGK1R820FRSR-H	MYMGK1R820ERSR MYMGK1R820ERSR-H
0.7V	75+0.36	68+2.4
1.0V	16+0.39	16
1.2V	10+0.75	10+0.62
1.5V	6.8+0.33	6.8+0.24
1.8V	5.1+0.27	5.1+0.2

Resistor Trim Equation

MYMGK1R820FRSR/MYMGK1R820FRSR-H

$$R_{trim}(\text{kohm}) = \frac{10 \times A}{(V_{out} - A)}$$

$$A = 0.617 + 0.01 \times (V_{out} - 0.6)$$

MYMGK1R820ERSR/MYMGK1R820ERSR-H

$$R_{trim}(\text{kohm}) = \frac{10 \times A}{(V_{out} - A)}$$

$$A = 0.612 + 0.01 \times (V_{out} - 0.6)$$

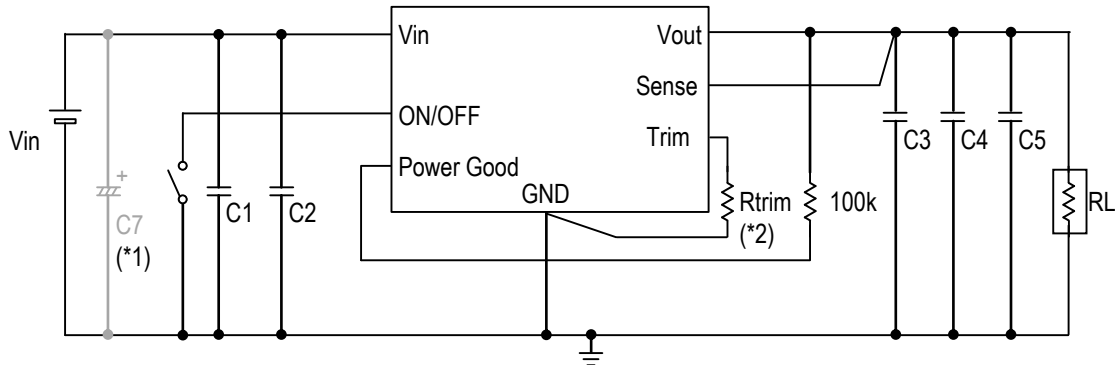
Output voltage depends on the value of capacitance of Cout in this product, the smaller Cout may cause the higher output voltage. The equations above are only reference, so please check output voltage and adjust Rtrim in user circumstances. To increase(decrease) output voltage is obtained by decreasing(increasing) value of Rtrim.

Power Good(P.G)

These products has power-good output that indicates high when switcher output is within the target. The power-good function is activated after soft-start has finished. If the output voltage becomes within +10% and -5% of the target value, internal comparators detect power-good state and the power-good signal becomes high after a 1-ms internal delay. If the output voltage goes outside of +15% or -10% of the target value, the power-good signal becomes low after two microsecond (2-μs) internal delay. The power-good output is an open drain output and must be pulled up internally.

APPENDIX

Test Circuit



*1: If there is a non-negligible parasitic impedance between the power supply and the converter, such as during evaluation, the optional input capacitor "C7" may be required to reduce the impedance. The recommended optional capacitor is an example. Please consider the optimum value for the case. This capacitor is usually an aluminum electrolytic type. It isn't necessary to place the capacitor near the input terminal of the converter.

This would typically be aluminum electrolytic type and does not need to be close to the input terminals of converter.

*2: Do not connect any additional components between the Trim pin and Vout or between the Trim and Sense pins. Use only the specified connections.

	MYMGK1R820FRSR MYMGK1R820FRSR-H *4.5≤Vin(V)≤5.5	MYMGK1R820FRSR MYMGK1R820FRSR-H *5.5≤Vin(V)≤8.0	MYMGK1R820ERSR MYMGK1R820ERSR-H
C1, C2	47uF/10V GRM32ER71A476KE15 (Murata)	22uF/25V GRM32ER71E226KE15 (Murata)	22uF/25V GRM32ER71E226KE15 (Murata)
C3, C4, C5	220uF/4V GRM32EC80G227ME05 (Murata)	220uF/4V GRM32EC80G227ME05 (Murata)	220uF/4V GRM32EC80G227ME05 (Murata)
Rtrim	1005, Chip resister	1005, Chip resister	1005, Chip resister
C7	No mount or Electrolytic Capacitor (if necessary)	No mount or Electrolytic Capacitor (if necessary)	No mount or Electrolytic Capacitor (if necessary)



This product is subject to the following [operating requirements](#) and the [Life and Safety Critical Application Sales Policy](#):
Refer to: <https://power.murata.com/en/requirements>

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